ELECTRONICS CO., LTD,

SPECIFICATION

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 PIN JACK
 HSP-251
 DATE: 2013.02.19

SPECIFICATION

1. Standard atmospheric condition:

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows:

Ambient temperature: 5° C to 35° C Relative humidity : 45% to 85% Air pressure : 85kPa to 106kPa

If there is any doubt about the results, measurements shall be made within the following limits:

Ambient temperature: 20±1°C

Relative humidity : 60% to 70% Air pressure : 86kPa to 106kPa

Operating temperature range: -25° C to 70° C Storage temperature range: -25° C to 85° C

Humidity range: 85% RH MAX.

- 2. Construction:
- 2.1 Mating limit:

Mating limit or range of between the plug and the spring of pin jack shall be not regulated.

2.2 Connection timing:

The pin jack shall be permitted with connection timing whether shorting or not between the mutually separated terminals or springs of the pin jack, during the plug inserting and extracting.

2.3 Creepage distance and spacing:

Creepage distance and spacing between mutually insulated parts shall be 0.3mm minimum, these distance and spacing shall be maintained with or without the gauge plug inserted.

ISSUE	DATE	WRTN	CHKD	APVD	DESCRIPTIONS
	2013.02.19	黃健瑋	郭素玲	郭遠峰	

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3. Electrical characteristics

	Item	Condition	Specifications
1	Rated voltage/Rated current		DC 34V 2A
2	Insulation resistance	A voltage of 500V D.C. shall be applied for 1 min. between mutually insulated metal parts after which measurement shall be made.	100 MΩ MIN.
3	Contact resistance	Measurement shall be made at with small current 1000 Hz (100mA MAX.)	30 mΩ MAX.
4	Dielectric strength	500V A.C. r.m.s (50 Hz to 60 Hz) for 1 minute. Trip current: 2mA	Without damage to parts, arcing or breakdown, etc.

4. Mechanical characteristics

	Item	Condition	Specifications
	Operating	The insertion force and the withdrawal force shall be measured with the mating plug as shown in Appendix attached.	
1	force	Insertion force	29.4N (3kgf) MAX.
		Withdrawal force	$2.94N\sim29.4N$ (0.3kgf \sim 3.0kgf)
2	Terminal strength	Every terminal shall be capable of withstand a force of 4.9N (0.5kgf) for 10 seconds.	Without cracks or excessive
3	Loosen strength of contact	The terminal shall be capable of withstand a force of 29.4N (3kgf) applied in any direction for 10 seconds.	
4	Strength of tapping part	The tapping part shall be capable of a torque of 98N-cm (10Kgf-cm) for 5 seconds by M3X8 tapping tight screw and panel (t=1).	Electrical and mechanical Characteristics shall be satisfied.

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	5. Endurance characteristics						
	Item	Condition	Specifications				
		The life test shall consist of 150 cycles of insertion					
	0	and withdrawal with gauge plug covered with a thin	Electrical and mechanical				
1	Operating endurance	coat of grease in order to prevent from heating or	Characteristics shall be				
	endurance	wearing, at a rate of 20 to 30 cycles per minutes under	satisfied.				
		no load.					
		Temperature : $40^{\circ}\text{C}\pm2^{\circ}\text{C}$	Electrical and mechanical				
		Relative humidity: $90\% \sim 95\%$ for 96 hours.	Characteristics shall be				
2	Humidity test	The testing jack shall be left alone for 30 minutes in a	satisfied.				
		room ambient, before measurement shall be made.					
		Insulation resistance	50 MΩ MIN.				
		The pin jack shall be subjected to temperature of					
3	Dry heat	$85^{\circ}\text{C}\pm2^{\circ}\text{C}$ for a period of 96 hours, then shall be					
		allowed to remain in room ambient conditions for 30	Electrical and mechanical				
		minutes. The nin iself shall be subjected to temperature of	Characteristics shall be				
		The pin jack shall be subjected to temperature of $-25^{\circ}\text{C}\pm3^{\circ}\text{C}$ for a period of 96 hours, then shall	satisfied.				
4	Cold	be allowed to remain in room ambient					
		conditions for 30 minutes.					
		The pin jack shall be subjected to the conditions as					
		shown in below, and then shall be returned and	Electrical and mechanical				
		allowed to remain in room ambient condition for 30	Characteristics shall be				
		minutes.	satisfied.				
	Commonito	90~96% RH 90~96% RH					
	Composite temperature /	80 65 65					
5	humidity cyclic						
	test	(2) 50 40 Hz 30 20 10 10 10 10 10 10 10 10 10 10 10 10 10					
		E 10 0					
		-10	47 49 49 99 94 99 97 94				
		0 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 Time in hours (h)	17 18 19 20 21 22 23 24				
		(4 cycles)					
		` '					

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PIN JACK			HSP	2-251	DATE : 2013.02.19	
Item			Condition		Specifications	
			Wave s	soldering Proces	SS	
		D CL F	Pb-Free Assembly			
		Profile Feature	Topside PCB	Padside PCB		
		Preheat -Temperature min -Temperature max -Time (ts min to max	120°C (Ts1 max)	110°C (Ts min) 150°C (Ts max) 75 sec	Electrical and mechanical characteristics shall be satisfied,	
		Peak/Classification Temperature	165°C (Tp₁)	260°C ±5°C (Tp)	and not show remarkable failure.	
		Time within 5°C of actual Temperature	f	10 sec (within 2 times every	Tarrure.	
		$\begin{array}{c} \text{(tp)} \\ \text{Time 25}^{\circ}\mathbb{C} \text{ to Peal} \end{array}$	ζ	time 2-3 sec) 3 minutes max		
		temperature				
			Semperature Profile are as below			
	Resistance to	About the plastic pro	roperties, Please refer to the data sheet of plastic.			
6	Soldering Heat	Temperature			2-3 sec	
	Test	Tp Ts max Ts min			Tp1 max TS1 max	
		Topside PCB				
			2	— Padside PCB		
Те		Soldering Iron Test Temperature of soldering Iron: 380±10°C Soldering time: 3±1 seconds			Same as Wave soldering Process	
		I	nsertion force		29.4N (3kgf) MAX.	
		W	Vithdrawal force		2.94N~29.4N (0.3kgf~3.0kgf)	

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	Item	Condition	Specifications
		Temperature of solder : 250°C±5°C	The soldered area shall be
7	Soldering test	Time of dip: 3±0.5 seconds	covered a minimum of 90% of
		Length of dip: 2±0.5mm (from top of terminal)	the surface being immersed.

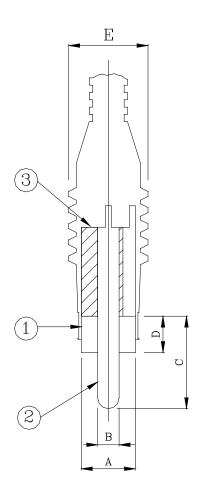
6.	. Soldering condition shelf life about 6 months	depend on	storage condition	of humidity,	temperature
	and others factors.				

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Mating Plug



- ① Plug cover
- 2 Plug pin
- ③ Insulator

Symbol	Dimension
A	(ø8.2)
В	$3.25^{+0}_{-0.15}$
С	14.0±0.5
D	5.5±0.5
E	12 Max

Unit: mm

(): Reference value

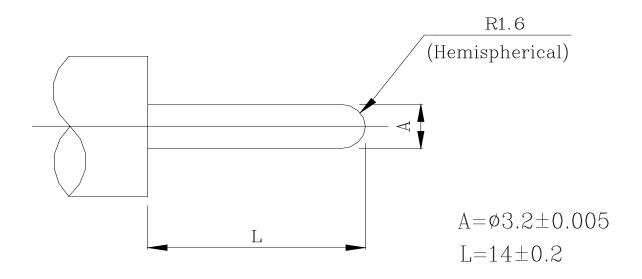
Note: Eccentricity to central axis shall be 0.15 mm or less.

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Gauge Plug



Surface roughness: Peak-to-valley height of 0.8 micron MAX.

For insertion and drawing force:

Material: Stainless steel.

Finish : Chromium plated.

For contact resistance:

Material: Brass

Finish: Silver plated.

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7. Endurance test sequence:

7. Endurance test sequence:											
	Test group Test sequence	A	В	С	D	E	F	G	Н	I	J
Test It	em										
3.2	Insulation resistance	1,6	1,6		1,6	1	1,6	1,6	1,6	1,6	
3.3	Contact resistance	3,8	3,8		3,8	3,7	3,8	3,8	3,8	3,8	
3.4	Dielectric strength	2,7	2,7		2,7	2,6	2,7	2,7	2,7	2,7	
4.1	Operating force	4,9	4,9		4,9	4,8	4,9	4,9	4,9	4	
4.2	Terminal strength	5									
4.3	Loosen strength of contact		5								
4.4	Strength of tapping part			1							
5.1	Operating endurance				5						
5.2	Humidity test					5					
5.3	Dry heat						5				
5.4	Cold							5			
5.5	Composite temperature/ humidity cyclic test								5		
5.6	Resistance to Soldering Heat Test									5	
5.7	Soldering test										1

Test sample quality : 2 pcs min. / group